## **BT139F series**

MAX.

800

800

16

140

UNIT

V

А

А

#### GENERAL DESCRIPTION

Passivated triacs in a full pack, plastic envelope, intended for use in applications requiring high bidirectional transient and blocking voltage capability and high thermal cycling performance. Typical applications include motor control, industrial and domestic lighting, heating and static switching.

DESCRIPTION

#### **PINNING - SOT186**

main terminal 1

main terminal 2

PIN

1

2

3

case

# case

QUICK REFERENCE DATA

PARAMETER

voltages

current

Repetitive peak off-state

Non-repetitive peak on-state

RMS on-state current

SYMBOL

 $V_{DRM}$ 

T(RMS)

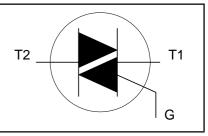
**PIN CONFIGURATION** 

I<sub>TSM</sub>



BT139F-

BT139F-



MAX.

600

600F

600

16

140

## LIMITING VALUES

isolated

gate

Limiting values in accordance with the Absolute Maximum System (IEC 134).

| SYMBOL                                  | PARAMETER   | CONDITIONS   | MIN.     | MAX.                            |                    | UNIT                  |
|---|---|--|----------|---------------------------------|--------------------|-----------------------|
| V <sub>DRM</sub>                        | Repetitive peak off-state voltages                              |  | -        | <b>-600</b><br>600 <sup>1</sup> | <b>-800</b><br>800 | V                     |
| I <sub>T(RMS)</sub><br>I <sub>TSM</sub> | RMS on-state current<br>Non-repetitive peak<br>on-state current | full sine wave; $T_{hs} \le 38$ °C<br>full sine wave; $T_j = 125$ °C prior<br>to surge; with reapplied V <sub>DRM(max)</sub> | -        |                                 | 6                  | A                     |
|   |   | t = 20 ms  | -        |                                 | 40                 | A                     |
| l <sup>2</sup> t                        | I <sup>2</sup> t for fusing                                     | t = 16.7 ms<br>t = 10 ms   | -        |                                 | 50<br>8            | A<br>A <sup>2</sup> s |
| dl <sub>⊤</sub> /dt                     | Repetitive rate of rise of on-state current after               | $I_{TM} = 20 \text{ A}; I_G = 0.2 \text{ A}; dI_G/dt = 0.2 \text{ A}/\mu \text{s}$   |          |                                 | •                  |                       |
|   | triggering  | T2+G+  | -        |                                 | 0                  | A/μs                  |
|   |   | T2+ G-<br>T2- G-   | -        |                                 | 0<br>0             | A/μs<br>A/μs          |
|   |   | T2- G+   | -        |                                 | 0                  | A/μs                  |
| I <sub>GM</sub>                         | Peak gate current   |  | -        |                                 |                    | Á                     |
| V <sub>GM</sub>                         | Peak gate voltage<br>Peak gate power                            |  | -        |                                 | 5                  | V<br>W                |
|   | Average gate power  | over any 20 ms period  | -        |                                 | .5                 | W                     |
| $T_{stg}$                               | Storage temperature<br>Operating junction<br>temperature        |  | -40<br>- | 15                              | 50<br>25           | °<br>C<br>C           |

<sup>1</sup> Although not recommended, off-state voltages up to 800V may be applied without damage, but the triac may switch to the on-state. The rate of rise of current should not exceed 15  $A/\mu s$ .

BT139F series

# **ISOLATION LIMITING VALUE & CHARACTERISTIC**

 $T_{hs}$  = 25 °C unless otherwise specified

| SYMBOL            | PARAMETER  | CONDITIONS  | MIN. | TYP. | MAX. | UNIT |
|-------------------|--|---|------|------|------|------|
| V <sub>isol</sub> | R.M.S. isolation voltage from all three terminals to external heatsink | f = 50-60 Hz; sinusoidal waveform;<br>R.H. ≤ 65% ; clean and dustfree | -    | -    | 1500 | V    |
| C <sub>isol</sub> | Capacitance from T2 to external heatsink                               | f = 1 MHz   | -    | 12   | -    | pF   |

#### THERMAL RESISTANCES

| SYMBOL                                      | PARAMETER   | CONDITIONS   | MIN. | TYP.         | MAX.            | UNIT              |
|---|---|--|------|--------------|-----------------|-------------------|
| R <sub>th j-hs</sub><br>R <sub>th j-a</sub> | Thermal resistance<br>junction to heatsink<br>Thermal resistance<br>junction to ambient | full or half cycle<br>with heatsink compound<br>without heatsink compound<br>in free air |      | -<br>-<br>55 | 4.0<br>5.5<br>- | K/W<br>K/W<br>K/W |

## STATIC CHARACTERISTICS

#### $T_i = 25$ °C unless otherwise stated

| SYMBOL          | PARAMETER                                | CONDITIONS  | MIN.      | TYP.       | MA       | AX.      | UNIT        |
|-----------------|--|---|-----------|------------|----------|----------|-------------|
| I <sub>GT</sub> | Gate trigger current                     | <b>BT139F-</b><br>V <sub>D</sub> = 12 V; I <sub>T</sub> = 0.1 A         |           |            |          | F        |             |
| GI              |  | T2+ G+  | -         | 5          | 35       | 25       | mA          |
|                 |  | T2+ G-<br>T2- G-  | -         | 8<br>10    | 35<br>35 | 25<br>25 | mA<br>mA    |
| IL.             | Latching current                         | $T_2-G_+$<br>V <sub>D</sub> = 12 V; I <sub>GT</sub> = 0.1 A             | -         | 22         | 70       | 70       | mA          |
| ·L              |  | T2+ G+<br>T2+ G-  | -         | 7          | 40       | 40       | mA          |
|                 |  | T2- G-  | -         | 20<br>8    | 60<br>40 | 60<br>40 | mA<br>mA    |
| I <sub>H</sub>  | Holding current                          | T2- G+<br>V <sub>D</sub> = 12 V; I <sub>GT</sub> = 0.1 A                | -         | 10<br>6    | 60<br>30 | 60<br>30 | mA<br>mA    |
| $V_{T} V_{GT}$  | On-state voltage<br>Gate trigger voltage | $I_{T} = 20 \text{ A}$<br>$V_{D} = 12 \text{ V}; I_{T} = 0.1 \text{ A}$ | -         | 1.2<br>0.7 |          | .6<br>.5 | V<br>V<br>V |
| I <sub>D</sub>  | Off-state leakage current                |   | 0.25<br>- | 0.4<br>0.1 | 0        | .5       | mA          |

# BT139F series

# **DYNAMIC CHARACTERISTICS**

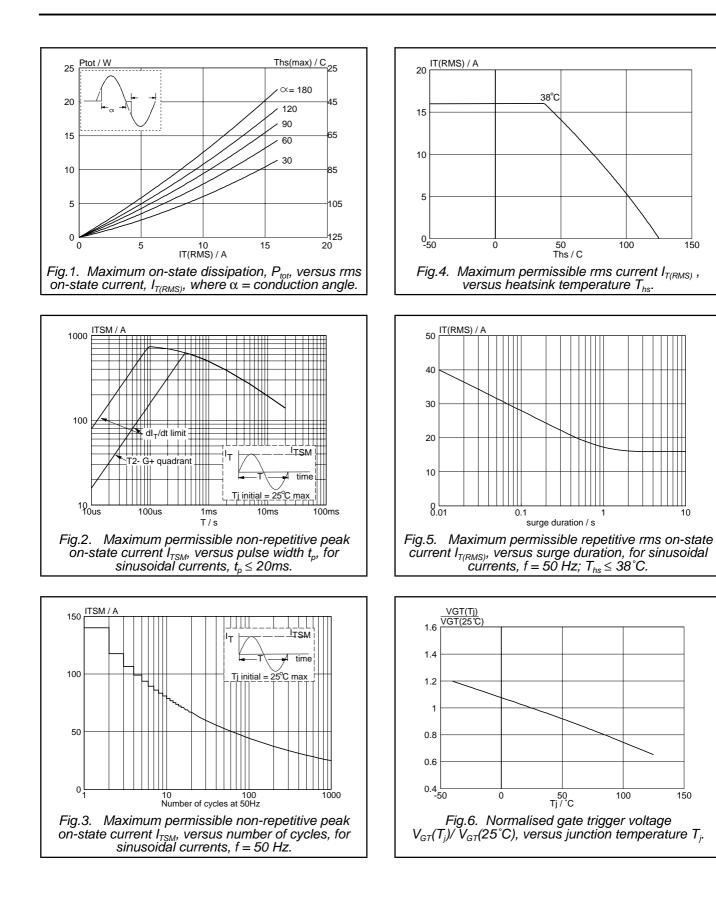
 $T_i = 25$  °C unless otherwise stated

| SYMBOL                | PARAMETER                                      | CONDITIONS   | М       | N.             | TYP. | MAX. | UNIT |
|-----------------------|--|--|---------|----------------|------|------|------|
| dV <sub>D</sub> /dt   | Critical rate of rise of off-state voltage     | BT139F-<br>$V_{DM} = 67\% V_{DRM(max)};$<br>$T_i = 125 °C; exponential$  | <br>100 | <b>F</b><br>50 | 250  | -    | V/µs |
| dV <sub>com</sub> /dt | Critical rate of change of commutating voltage | waveform; gate open<br>circuit<br>$V_{DM} = 400 \text{ V}; \text{ T}_{j} = 95 ^{\circ}\text{C};$<br>$I_{T(RMS)} = 16 \text{ A};$<br>$dI_{com}/dt = 7.2 \text{ A/ms}; \text{ gate}$ | -       | -              | 20   | -    | V/µs |
| t <sub>gt</sub>       | Gate controlled turn-on time                   | open circuit<br>$I_{TM} = 20 \text{ A}; \text{ V}_D = \text{V}_{DRM(max)};$<br>$I_G = 0.1 \text{ A}; \text{ dI}_G/\text{dt} = 5 \text{ A}/\mu\text{s}$                             | -       | -              | 2    | -    | μs   |

# **BT139F** series

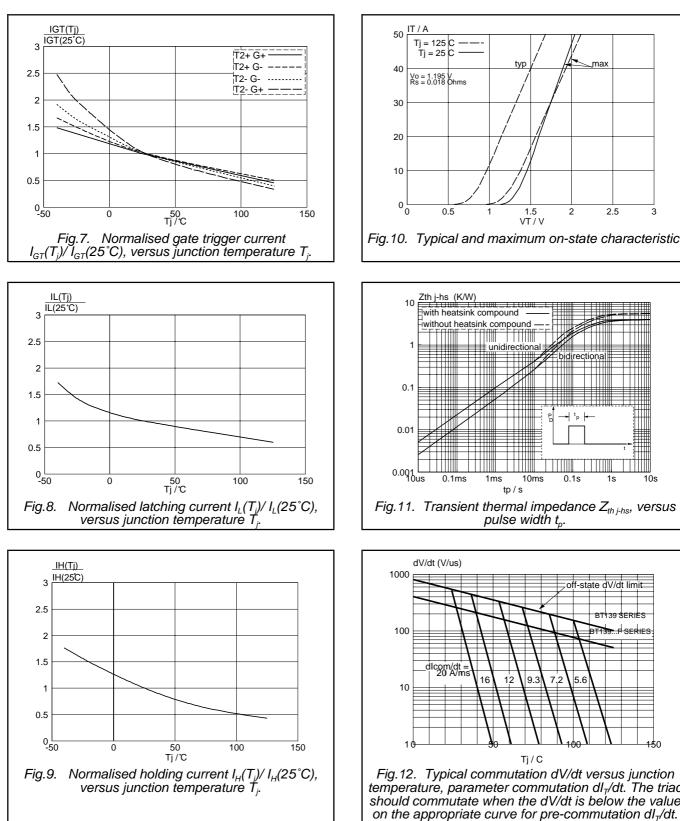
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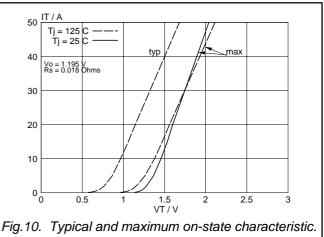
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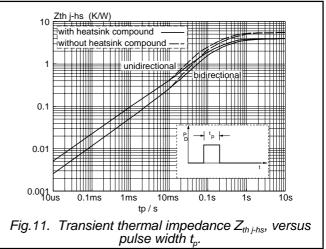


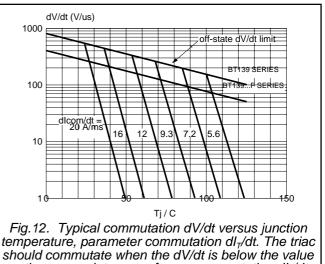
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## **BT139F** series



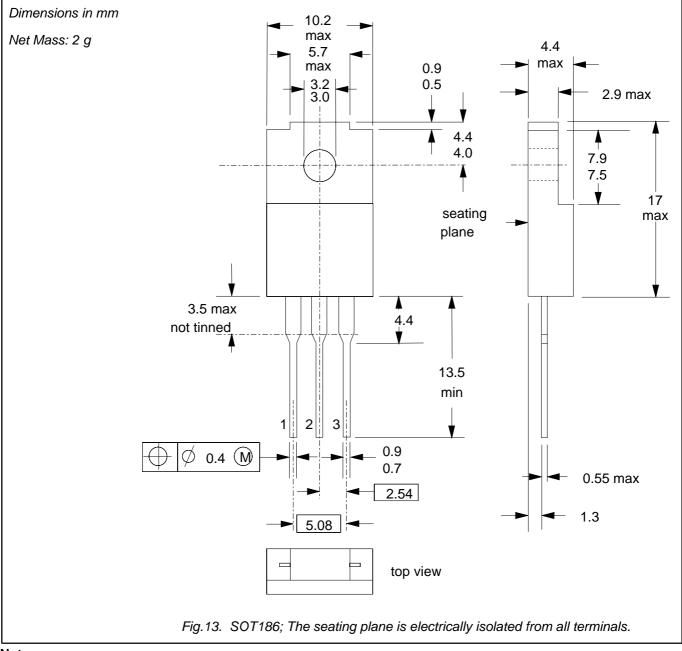






BT139F series

## **MECHANICAL DATA**



#### Notes

Refer to mounting instructions for F-pack envelopes.
Epoxy meets UL94 V0 at 1/8".

## BT139F series

## DEFINITIONS

| DATA SHEET STATUS   |               |   |  |  |  |
|---|---------------|---|--|--|--|
| DATA SHEET PRODUCT<br>STATUS <sup>2</sup> STATUS <sup>3</sup> |               | DEFINITIONS   |  |  |  |
| Objective data  | Development   | This data sheet contains data from the objective specification for product development. Philips Semiconductors reserves the right to change the specification in any manner without notice  |  |  |  |
| Preliminary data  | Qualification | This data sheet contains data from the preliminary specification.<br>Supplementary data will be published at a later date. Philips<br>Semiconductors reserves the right to change the specification without<br>notice, in ordere to improve the design and supply the best possible<br>product                                    |  |  |  |
| Product data  | Production    | This data sheet contains data from the product specification. Philips<br>Semiconductors reserves the right to make changes at any time in<br>order to improve the design, manufacturing and supply. Changes will<br>be communicated according to the Customer Product/Process<br>Change Notification (CPCN) procedure SNW-SQ-650A |  |  |  |

#### Limiting values

Limiting values are given in accordance with the Absolute Maximum Rating System (IEC 134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of this specification is not implied. Exposure to limiting values for extended periods may affect device reliability.

#### Application information

Where application information is given, it is advisory and does not form part of the specification.

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